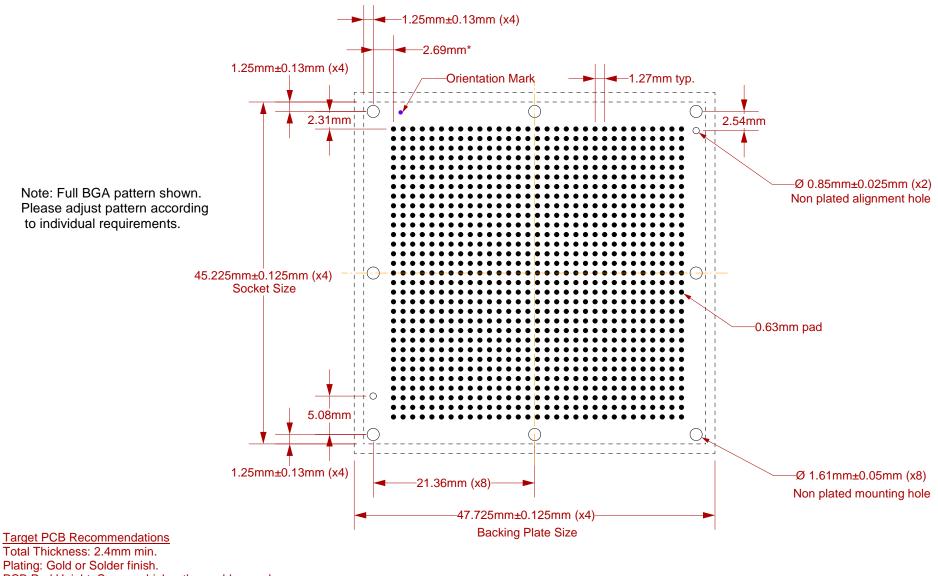


SG-BGA-6205 Drawing	Status: Released	Scale:	: -	Rev: B	All tolerances: ±0.125mm (unless s otherwise). Materials and specifica	
© 2006 IRONWOOD ELECTRONICS, INC. 11351 Rupp Drive, Suite 400, Burnsville, MN 55337	Drawing: J. Glab		Date: 10/30/06		are subject to change without notice	
Tele: (952) 229-8200 www.ironwoodelectronics.com	File: SG-BGA-6205 Dwg		Modified: 7/2	21/09	PAGE 1 of 4	

0.125mm (unless stated erials and specifications ange without notice.



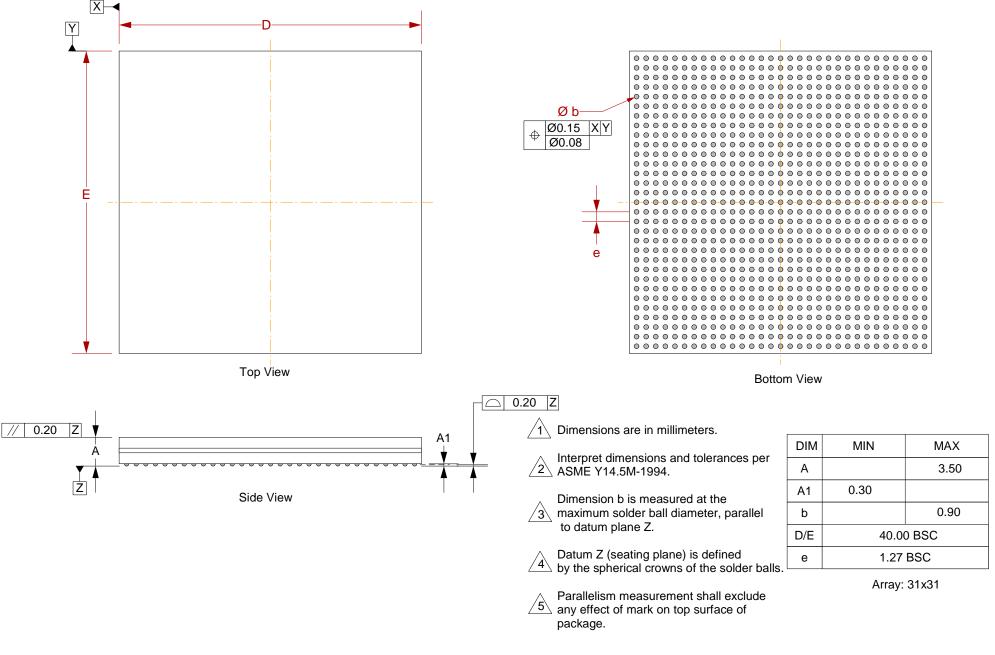
PCB Pad Height: Same or higher than solder mask.

NOTE: Steel backing plate may be required based on end user's application.

Recommended PCB Layout Tolerances: ±0.025mm [±0.001"] unless stated otherwise.

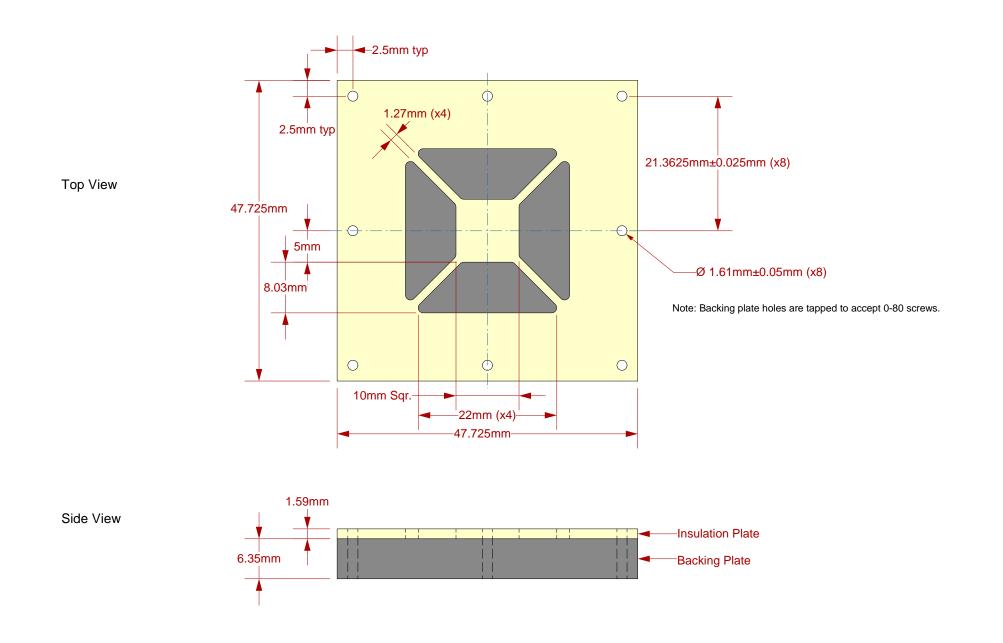
SG-BGA-6205 Drawing	Status: Released	Scale	: 2:1	Rev: B	
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SG-BGA-6205 Drawing		Status: Released	Scale: -		Rev: B
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		File: SG-BGA-6205 Dwg		Modified: 7/21/09	



Description: Insulation Plate and Backing Plate.

	SG-BGA-6205 Drawing	Status: Released Scal		: -	Rev: B
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		File: SG-BGA-6205 Dwg		Modified: 7/21/09	

All dimensions are in mm. All tolerences are +/- 0.125mm. (Unless stated otherwise)

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